## **Electronic Acknowledgement Receipt** FES ID: 1116883 Application Number: 10699975 Confirmation Number: 5032 Mask layer and interconnect structure for dual damascene Title of Invention: semiconductor manufacturing First Named Inventor: Isaiah O. Oladeji Customer Number: 29391 Filer: Charles W. Gaines/Elizabeth Schumacher Filer Authorized By: Charles W. Gaines Attorney Docket Number: Jessen 7-1-4/(284) Receipt Date: 18-JUL-2006 Filing Date: 02-NOV-2003 Time Stamp: 12:05:40 Application Type: Utility International Application Number: Payment information:

## Submitted with Payment File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Power of Attorney (may include Associate POA)	POA.pdf	151475	no	1

no

Warnings:										
Information:										
2	Assignee showing of ownership per 37 CFR 3.73(b).	Statement_373b.pdf	438074	no	7					
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## New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.